

RF360 Europe GmbH

A Qualcomm – TDK Joint Venture

# **SAW Components**

# **BAW Bandpass Filter**

WLAN 2G

Series/type:B8852Ordering code:B39242B8852P810

Date:December 18, 2015Version:2.0

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2442 MHz

SAW Components
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### **BAW Bandpass Filter**

Data sheet

### Table of contents

1 Application	
1 <u>Application</u>	
3 Package	
3 <u>Package</u> 4 <u>Pin configuration</u>	4
5 Matching circuit	5
6 Characteristics	6
7 Maximum ratings	7
8 <u>Transmission coefficient</u>	8
9 Reflection coefficients	9
10 Packing material	
11 Marking	
12 Soldering profile	
13 Annotations	
14 <u>Cautions and warnings</u>	
Contact and Important notes.	



### **BAW Bandpass Filter**

Data sheet

### 1 Application

- Low-loss BAW RF single filter for Bluetooth/WLAN with LTE Band 7 Rx / Band 40 / Band 38 coexistence.
- Usable passband 79.0 MHz.
- Unbalanced to unbalanced operation.
- Filter impedance 50  $\Omega$ .
- High out of band selectivity.
- Excellent insertion loss.
- 2 Features
- Package size 1.1±0.1 mm × 0.9±0.1 mm.
- Package height 0.45 mm (max.).
- Approximate weight 0.0012 g.
- RoHS compatible.
- Package for Surface Mount Technology (SMT).
- Ni/Au-plated terminals.
- Electrostatic Sensitive Device (ESD).
- Moisture Sensitivity Level 3 (MSL3).



**Figure 1:** Picture of component with example of marking.

### B8852

### 2442 MHz



2442 MHz

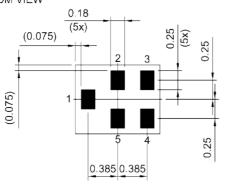
### **SAW Components**

### **BAW Bandpass Filter**

### Data sheet

## 3 Package

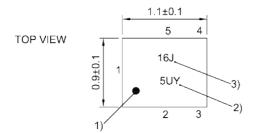
BOTTOM VIEW



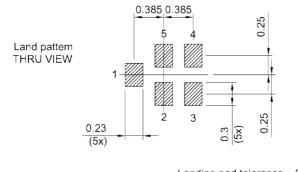
Pad and pitch tolerance ±0.05

### SIDE VIEW





- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number



Landing pad tolerance -0.02 **Figure 2:** Drawing of package with package height A = 0.45 mm (max.). See Simplified drawings (p. 16).

### 4 Pin configuration

- 1 Input (to PA (unbalanced))
  - Output (to ANT (unbalanced))
- 2, 3, 5 Ground

**4** 



2442 MHz

SAW Components

### **BAW Bandpass Filter**

Data sheet

### 5 Matching circuit

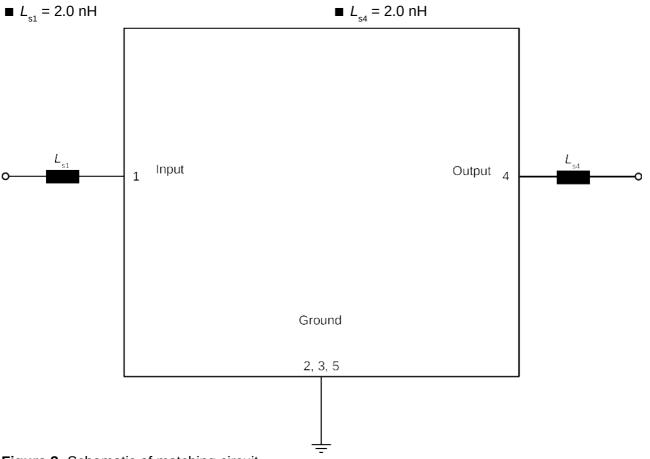


Figure 3: Schematic of matching circuit.



2442 MHz

SAW Components

### **BAW Bandpass Filter**

Data sheet

### 6 Characteristics

Temperature range for specification
Input terminating impedance
Output terminating impedance

 $\begin{array}{ll} T & = -30 \ ^{\circ}\text{C to} +85 \ ^{\circ}\text{C} \\ Z_{_{\text{IN}}} & = 50 \ \Omega \text{ with ser. } 2.0 \text{ nH} \\ Z_{_{\text{OUT}}} & = 50 \ \Omega \text{ with ser. } 2.0 \text{ nH} \end{array}$ 

Characteristics				min.	<b>typ.</b> @+25 °C	max.	
Center frequency			f <sub>c</sub>		2442		MHz
Maximum insertion attenuation			α <sub>max</sub>				
Channel 1	2403.12420.9	MHz		_	1.0 <sup>1)</sup>	1.8 <sup>1)</sup>	dB
Channel 2	2408.12425.9	MHz		_	0.81)	1.8 <sup>1)</sup>	dB
Channel 3-10	2413.12465.9	MHz		_	0.71)	1.8 <sup>1)</sup>	dB
Channel 11	2453.12470.9	MHz		_	0.81)	1.8 <sup>1)</sup>	dB
Channel 12	2458.12475.9	MHz		_	0.81)	1.8 <sup>1)</sup>	dB
Channel 13	2463.12480.9	MHz		_	0.91)	1.8 <sup>1)</sup>	dB
Maximum VSWR			VSWR <sub>max</sub>				
Channel 1-13 @ input port	2403.12480.9	MHz		—	1.6	2.4	
Channel 1-13 @ output port	2403.12480.9	MHz		—	1.6	2.4	
Minimum attenuation			$\alpha_{_{min}}$				
	100 1805	MHz		27	31	_	dB
	1805 2170	MHz		29	33	_	dB
	23002360	MHz		39	44	_	dB
	2360 2365	MHz		38 <sup>2)</sup>	47 <sup>2)</sup>	_	dB
	23652370	MHz		38 <sup>2)</sup>	43 <sup>2)</sup>	_	dB
	23702380	MHz		6 <sup>2)</sup>	41 <sup>2)</sup>	_	dB
	2550 2570	MHz		39	44	_	dB
	2570 2620	MHz		34	39	_	dB
	2620 2690	MHz		33	38	_	dB
	48005805	MHz		35	39	_	dB
	72007500	MHz		30	36	_	dB

1) Averaged value within each Wifi channel width of 17.8 MHz.

2) Averaged values of linear S-parameter over any 5MHz.



### **BAW Bandpass Filter**

B8852

2442 MHz

Data sheet

### 7 Maximum ratings

T <sub>stg</sub> =	= -40 °C to +90 °C	
V <sub>DC</sub> =	= 5.0 V <sup>4)</sup>	
$V_{\rm ESD}^{(1)}$	50 V	Machine model.
$V_{\rm ESD}^{2)}$	300 V	Human body model.
$V_{\rm ESD}^{3)}$	600 V	Charged device model.
P <sub>IN</sub>		
	24 dBm	20 MHz OFDM signal for 5000 h @ 65 °C.
	5.0 dBm	Continuous wave for 5000 h @ 65 °C.
	$V_{\rm DC} = V_{\rm ESD}^{(1)}$ $V_{\rm ESD}^{(2)}$ $V_{\rm ESD}^{(3)}$	$V_{DC} = 5.0 V^{4}$ $V_{ESD}^{1} 50 V$ $V_{ESD}^{2} 300 V$ $V_{ESD}^{3} 600 V$ $P_{IN}$ 24 dBm

<sup>1)</sup> According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses.

<sup>2)</sup> According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse.

<sup>3)</sup> According to JESD22-C101C (CDM – Field Induced Charged Device Model), 3 negative & 3 positive pulses.

<sup>4)</sup> 168h Damp Heat Steady State acc. To IEC60068-2-67 Cy.



### **BAW Bandpass Filter**

B8852

2442 MHz

Data sheet

### 8 Transmission coefficient

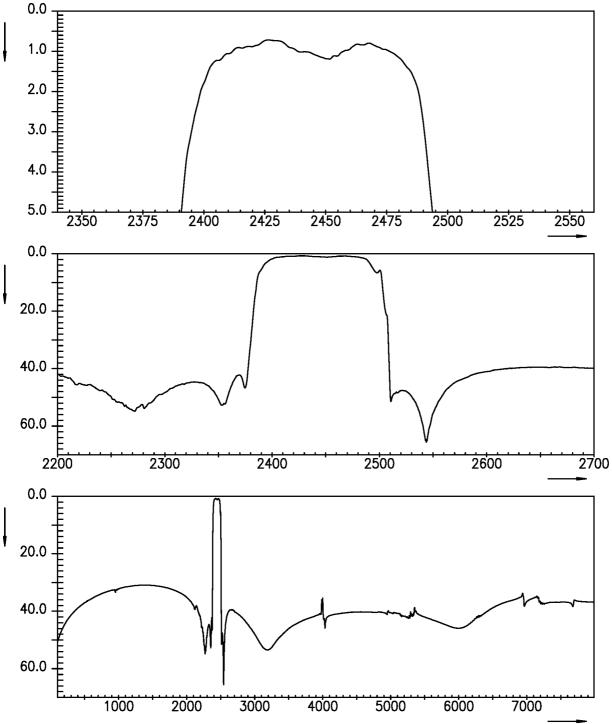


Figure 4: Attenuation.



2442 MHz

SAW Components

### **BAW Bandpass Filter**

Data sheet

### 9 Reflection coefficients

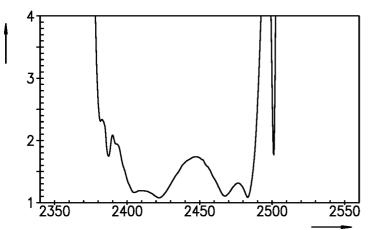


Figure 5: Reflection coefficient at IN port.

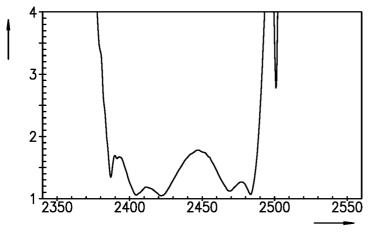
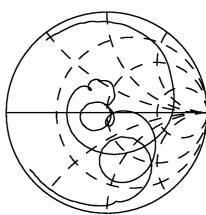
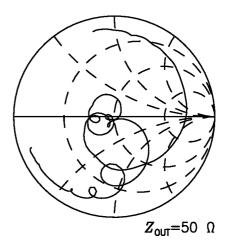


Figure 6: Reflection coefficient at OUT port.



Z<sub>IN</sub>=50 Ω





2442 MHz

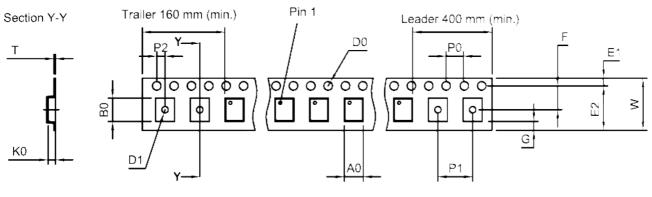
### **SAW Components**

### **BAW Bandpass Filter**

Data sheet

### 10 Packing material

### 10.1 Tape



User direction of unreeling

Figure 7: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A <sub>0</sub>	1.02±0.05 mm
$B_0$	1.22±0.05 mm
$D_0$	1.55±0.05 mm
$D_1$	0.55±0.1 mm
E1	1.75±0.1 mm

E <sub>2</sub>	6.25 mm (min.)
F	3.5±0.05 mm
G	_
K <sub>0</sub>	0.6±0.05 mm
P <sub>0</sub>	4.0±0.1 mm

<b>P</b> <sub>1</sub>	2.0±0.1 mm
P <sub>2</sub>	2.0±0.05 mm
Т	0.25±0.03 mm
W	8.0+0.3/-0.1 mm

**Table 1:** Tape dimensions.

### 10.2 Reel with diameter of 180 mm

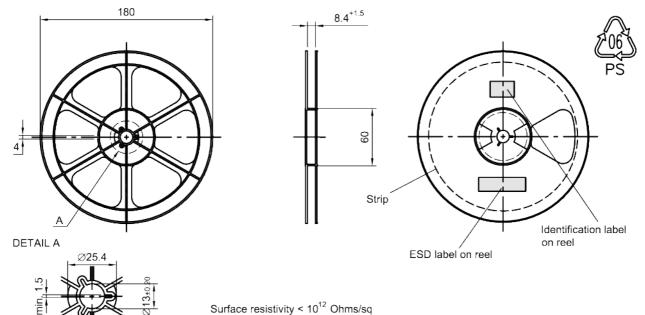
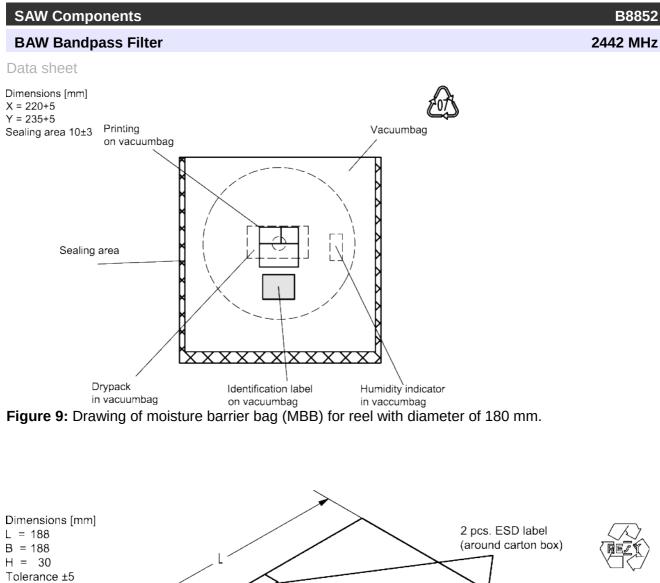
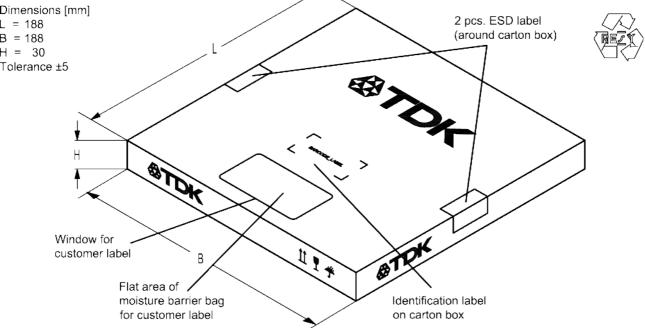
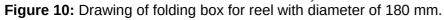


Figure 8: Drawing of reel (first-angle projection) with diameter of 180 mm.











### **BAW Bandpass Filter**

B8852

2442 MHz

Data sheet

### 10.3 Reel with diameter of 330 mm

4

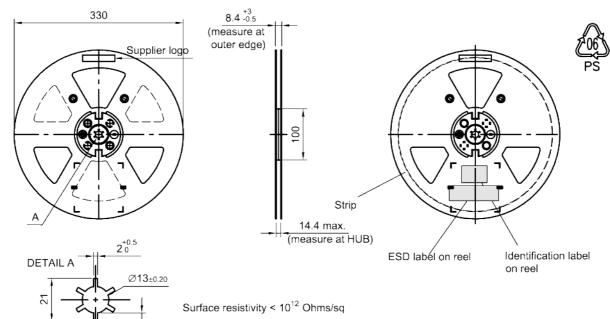
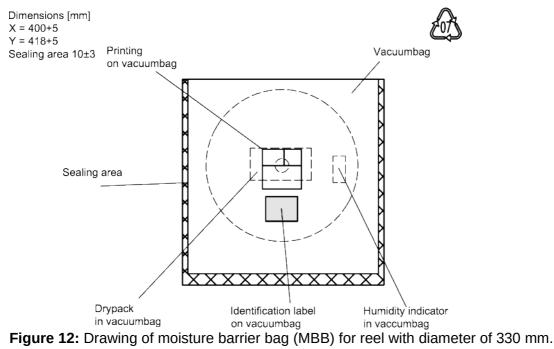


Figure 11: Drawing of reel (first-angle projection) with diameter of 330 mm.



# ⊗TDK

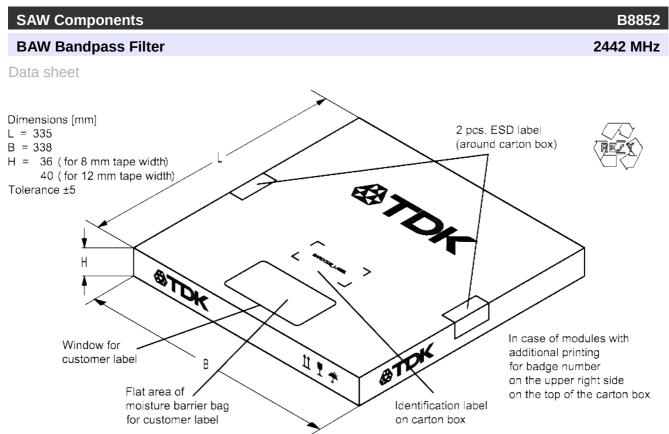


Figure 13: Drawing of folding box for reel with diameter of 330 mm.

### 11 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:			
The 4 digit type number of the ordering code, is encoded by a special BASE32 code into a 3 digit mar		e.g., B3	xxxxB <b>1234</b> xxxx,
Example of decoding type number marking on device <b>16J</b> $1 \times 32^2 + 6 \times 32^1 + 18$ (=J) $\times 32^0$ The BASE32 code for product type B8852 is 8MM.	=> =	ir	n decimal code. 1234 1234
■ Lot number:			
The last 5 digits of the lot number, are encoded based on a special BASE47 code into a 3		e.g., ng.	<b>12345</b> ,
Example of decoding lot number marking on device 5UY $5 \times 47^2 + 27$ (=U) $\times 47^1 + 31$ (=Y) $\times 47^0$	=> =	ir	n decimal code. <b>12345</b> <b>12345</b>

# Please read **Cautions and warnings** and **Important notes** at the end of this document.

### SAW Components

### **BAW Bandpass Filter**

Data sheet

Adopted BASE32 code for type number			
Decimal	Base32	Decimal	Base32
value	code	value	code
0	0	16	G
1	1	17	Н
2	2	18	J
3	3	19	K
4	4	20	М
5	5	21	N
6	6	22	Р
7	7	23	Q
8	8	24	R
9	9	25	S
10	А	26	Т
11	В	27	V
12	С	28	W
13	D	29	Х
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal	Base47	Decimal	Base47
value	code	value	code
0	0	24	R
1	1	25	S
2	2	26	Т
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	Х
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	В	35	f
12	С	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	V
17	Н	41	١
18	J	42	?
19	K	43	{
20	L	44	}
21	М	45	<
22	N	46	>
23	Р		

**Table 2:** Lists for encoding and decoding of marking.



### B8852 2442 MHz



2442 MHz

### SAW Components

### **BAW Bandpass Filter**

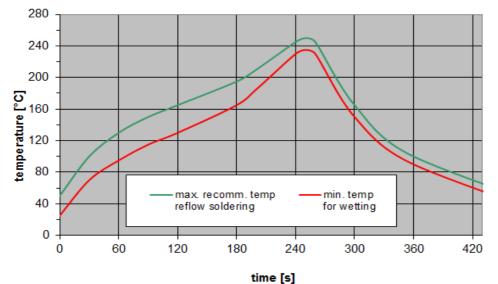
Data sheet

### 12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 –  $3^{rd}$  edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s		
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s		
<i>T</i> > 220 °C	30 s to 70 s		
<i>T</i> > 230 °C	min. 10 s		
<i>T</i> > 245 °C	max. 20 s		
<i>T</i> ≥ 255 °C	_		
peak temperature $T_{\text{peak}}$	250 °C +0/-5 °C		
wetting temperature $T_{min}$	230 °C +5/-0 °C for 10 s ± 1 s		
cooling rate	≤ 3 K/s		
soldering temperature T	measured at solder pads		
Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95 5Ag3			

 Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).



**Figure 14:** Recommended reflow profile for convection and infrared soldering – lead-free solder.

Please read **Cautions and warnings** and **Important notes** at the end of this document.



2442 MHz

### SAW Components

### **BAW Bandpass Filter**

Data sheet

### 13 Annotations

### 13.1 Matching coils

See TDK inductor pdf-catalog <u>http://www.tdk.co.jp/tefe02/coil.htm#aname1</u> and Data Library for circuit simulation <u>http://www.tdk.co.jp/etvcl/index.htm</u>.

### **13.2 RoHS compatibility**

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

### **13.3** Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local EPCOS sales office.

### **13.4** Ordering codes and packing units

Packing unit
15000 pcs
5000 pcs

 Table 4: Ordering codes and packing units.

### **14** Cautions and warnings

### 14.1 Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.epcos.com/orderingcodes.

### 14.2 Moldability

Before using in overmolding environment, please contact your local EPCOS sales office.

### 14.3 Simplified drawings

### Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on EPCOS internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of EPCOS, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

### Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

### **Projection method**

Unless otherwise specified first-angle projection is applied.



2442 MHz

### **BAW Bandpass Filter**

Data sheet

### **Contact and Important notes**

For further information please contact your local EPCOS sales office or visit our web page at <u>www.epcos.com</u>.

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